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FAN5776

同步升压型和串联/并联 10-LED 驱动器

特性

- 同步电流模式升压转换器
- 25 mA时驱动多达10个LED，各以5串LED（2个LED为一串）的配置来驱动
- 5 LED 输出：高侧电流源
- 具有单独使能和PWM调光控制的3x2-LED通道和2x2-LED通道的两个默认组以支持各种照明应用，如：
 - 双LCD显示器背光，LCD显示器加键盘照明
- 升压PFM模式最大化轻负载下的效率
- 2.3 V至5.5 V的输入电压范围
- 1.8 MHz开关频率
- 输入欠压闭锁 (UVLO)
- 输出过压保护 (OVP)
- 短路和热关断保护 (TSD)
- 12焊球、0.4 mm间距、1.42 x 1.66 x 0.50 mm WLCSP

应用

- 中型和大型LCD模块
- 移动电话、智能电话
- 智能本、网本、MID
- 便携式电脑
- WLAN DC-DC 转换器模块
- PDA、DSC、PMP 以及 MP3 播放器

说明

FAN5776是同步、恒流LED驱动器，能够有效驱动多达十个LED（五个一串），每字符串配置两个串联LED。针对小尺寸应用而优化，1.8 MHz 的固定开关频率允许使用片状电感和电容。

为了安全起见，该器件集成了过压、短路检测以及热关断保护。此外，如果电池电压过低，则会触发输入欠压闭锁保护。

FAN5776由低压差、高端电流源组成，能够高效地将电池电源传送到LED。通过在芯片对地的内部参考电压间连接一个串联RSET 电阻对 LED 电流进行控制。

在运行过程中，FAN5776可在PWM调光的关闭周期保持 C_{OUT} 上的升压稳压器电压，这有助于最大限度地减少可闻声。

FAN5776是采用极薄型设计、外形小巧（1.42 x 1.66 x 0.50 mm）的12凸块WLCSP封装，符合环保标准和RoHS标准。

订购信息

| 器件编号 | 温度范围 | 封装 | 包装 |
|------------|-----------|---|----|
| FAN5776UCX | -40至85° C | 12焊球、晶圆级芯片尺寸封装 (WLCSP) 1.42 x 1.66 x 0.50 mm, 0.40 mm间距 | 卷带 |

框图

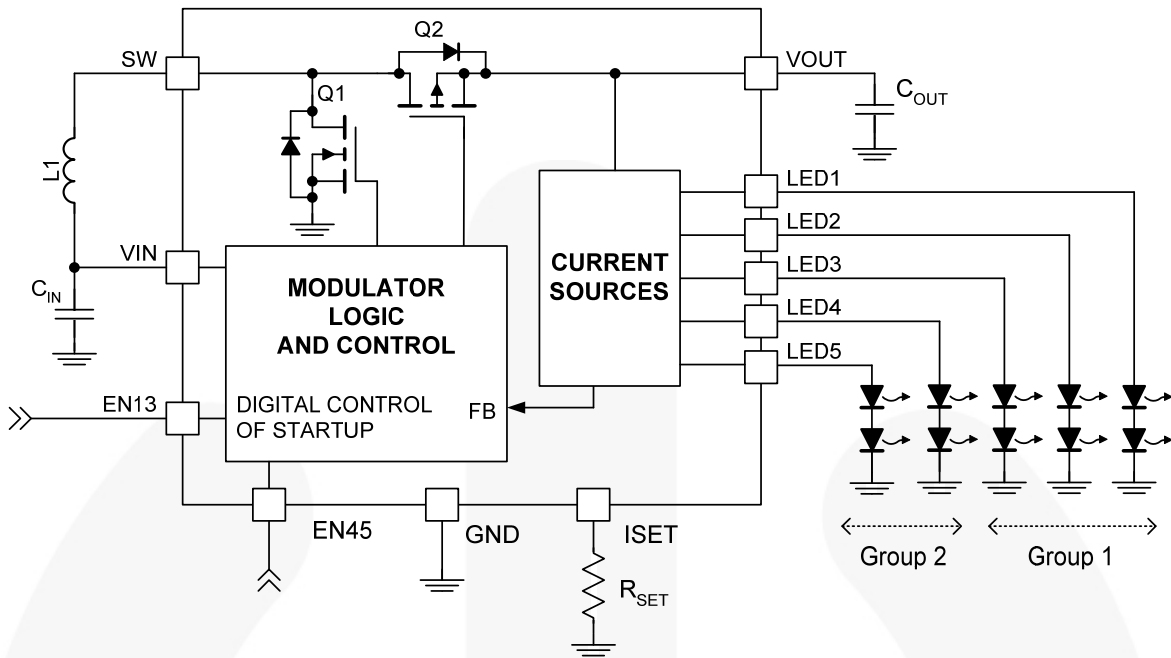


图 1. 典型应用框图

表 1. 建议使用的外部器件

| 组件 | 说明 | 厂商 | 参数 | 最小值 | 典型值 | 最大值 | 单位 |
|------------------|---------------------------|-----------------------------|----|------|------|------|---------------|
| L1 | $I_{L1} = 500 \text{ mA}$ | 各种 | L | 2.45 | 4.70 | | μH |
| | | | R | | | 0.30 | Ω |
| R _{SET} | 1%或更好 | 各种 | R | 20 | | 200 | k Ω |
| C _{OUT} | 10 μF X5R 或更好 | Murata GRM219R61A116UE82 | C | 4.2 | 10.0 | 20.0 | μF |
| C _{IN} | 2.2 μF X5R 或更好 | Murata GRM155R61A225KE95 | C | | 2.2 | | μF |



引脚布局

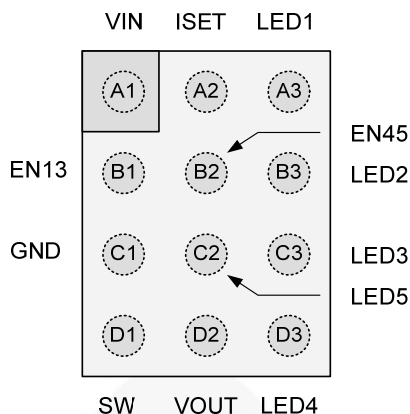


图 2. 顶部视图（焊点朝下）

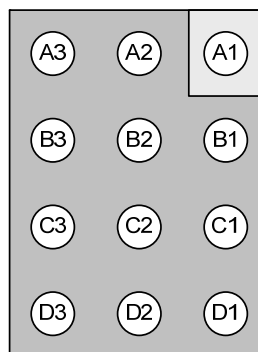


图 3. 底部视图（焊点朝上）

引脚定义

| 引脚号 | 名称 | 说明 |
|-----|------|--|
| A1 | VIN | 输入电压 |
| A2 | ISET | LED电流通过电阻 R_{SET} 将此引脚连接至GND来设置。电阻值设置LED灯串的电流。 |
| A3 | LED1 | LED灯串#1输出 |
| B1 | EN13 | LED1、LED2和LED3的使能/PWM引脚。此引脚上的逻辑LOW关闭LED1、LED2和LED3中的LED驱动器。IC在两个使能引脚（EN13和EN45）均设置为LOW后30 ms关闭。其连接至250 k Ω 的内部下拉电阻。 |
| B2 | EN45 | LED4和LED5的使能/PWM引脚。此引脚上的逻辑LOW关闭LED4和LED5中的LED驱动器。IC在两个使能引脚（EN13和EN45）均设置为LOW后30 ms关闭。其连接至250 k Ω 的内部下拉电阻。 |
| B3 | LED2 | LED灯串#2输出 |
| C1 | GND | 接地。所有电源和模拟信号均参考此引脚。 |
| C2 | LED5 | LED灯串#5输出 |
| C3 | LED3 | LED灯串#3输出 |
| D1 | SW | 开关节点。电感L1连接在VIN和该引脚之间。 |
| D2 | VOUT | 升压输出电压用于提供LED电流源。此电压调节为确保所有有源LED电流源上有足够电压所需的最小值。 |
| D3 | LED4 | LED灯串#4输出 |

绝对最大额定值

应力超过绝对最大额定值，可能会损坏器件。在超出推荐的工作条件的情况下，该器件可能无法正常工作，所以不建议让器件在这些条件下长期工作。此外，过度暴露在高于推荐的工作条件下，会影响器件的可靠性。绝对最大额定值仅是应力规格值。

| 符号 | 参数 | 最小值 | 最大值 | 单位 |
|------------|----------------------|--------------------|----------------|----|
| V_{IN} | 电源电压 | -0.3 | 6.0 | V |
| V_{ISET} | ISET电压 | -0.3 | $V_{IN} + 0.3$ | V |
| V_{EN} | EN13和EN45引脚最大电压 | -0.3 | 6.0 | V |
| V_{OVP} | VOUT、SW和LEDx驱动引脚最大电压 | -0.3 | 11.0 | V |
| ESD | 静电放电防护等级 | 人体模型满足JESD22-A114 | 2 | kV |
| | | 充电器件模型 JESD22-C101 | 1 | |
| T_A | 操作环境温度 | -40 | +85 | °C |
| T_J | 结温 | -40 | +150 | °C |
| T_{STG} | 存储温度 | -65 | +150 | °C |
| T_L | 引脚焊接温度，10秒 | | +260 | °C |

推荐工作条件

推荐的操作条件定义了器件的真实工作条件。指定推荐的工作条件，以确保器件的最佳性能达到数据表中的规格。飞兆不建议超出额定或依照绝对最大额定值进行设计。

| 符号 | 参数 | 最小值 | 典型值 | 最大值 | 单位 |
|---------------|-----------------------------|-----|-----|------|----|
| V_{IN} | V_{IN} 电源电压 | 2.3 | 3.7 | 5.5 | V |
| V_{OUT} | V_{OUT} 电压 ⁽¹⁾ | 3.5 | | 8.5 | V |
| $I_{LED(FS)}$ | 每通道满量程LED电流 | 2.5 | | 25.0 | mA |
| T_A | 环境温度 | -40 | | +85 | °C |
| T_J | 结温 | -40 | | +125 | °C |

注：

1. 最小 V_{OUT} 必须为3.5 V，以保证每个LED引脚的最大LED电流为25 mA。否则器件从内部设置最小 V_{OUT} 为 $V_{IN} + 0.3$ V，并且LED驱动器压降也相应增加（如果LED $V_F < V_{IN}$ ，其中 $V_F = V_{OUT} - 0.3$ V）。

热性能

结-环境之间热阻与具体应用和电路板布局有关。该数据由2s2p四层板测得，符合JESD51-JEDEC标准。特别注意的是，不要超过给定环境温度 T_A 时的结温 $T_{J(MAX)}$ 。

| 符号 | 参数 | 最小值 | 典型值 | 最大值 | 单位 |
|---------------|----------|-----|-----|-----|------|
| θ_{JA} | 结-环境之间热阻 | | 90 | | °C/W |

电气规格

若无其他说明： $V_{IN} = 2.3\text{ V}$ 至 5.5 V ， $T_A = -40^\circ\text{C}$ 至 $+85^\circ\text{C}$ ，以及EN13和EN45 = “1”。典型值为 $V_{IN} = 3.7\text{ V}$ 、 $T_A = 25^\circ\text{C}$ 、 $V_{OUT} = 6.8\text{ V}$ 、 $I_{LED1-5} = 20\text{ mA}$ 。电路和器件依据图1。

| 符号 | 参数 | 条件 | 最小值 | 典型值 | 最大值 | 单位 | |
|--------------------------|-------------------------------------|--|------------------------------|------|-----|-------------------|---|
| 电源 | | | | | | | |
| I_{SD} | 关断电流 | 器件被禁用，(EN13 = EN45 = “0”), $V_{IN} = 2.3\text{ V}$ 至 4.5 V | | 0.1 | 4.0 | μA | |
| V_{UVLO} | 欠压闭锁阈值 | V_{IN} 上升 | | 2.1 | 2.2 | V | |
| | | V_{IN} 下降 | 1.8 | 1.9 | | V | |
| V_{UVHYS} | 欠压锁定滞环宽度 | | | 200 | | mV | |
| 振荡器 | | | | | | | |
| f_{SW} | 频率 | PWM模式CCM | | 1.8 | | MHz | |
| 升压稳压器 | | | | | | | |
| I_{LIM-PK} | 峰值开关限流Limit ⁽²⁾ | 开环， $V_{IN} = 2.5\text{ V}$ 至 5.5 V | 445 | 525 | 640 | mA | |
| $I_{SOFT-PK}$ | Soft-Start峰值开关电流 | 开环 | | 250 | | mA | |
| I_{LOAD} | 最大连续输出电流 ⁽³⁾ | $V_{IN} > 2.5\text{ V}$ | 100 | | | mA | |
| LED电流驱动器特性 | | | | | | | |
| $\Delta I_{LED}/I_{LED}$ | 对 V_{IN} 变化的线路瞬态响应 ⁽³⁾ | 对350 mV脉冲的线路瞬态响应 | | | 10 | % | |
| | | 对在20 ms期间集成的350 mV脉冲的响应 | | | 1 | | |
| V_{LED_DO} | LED驱动器压差 ⁽⁵⁾ | | | 290 | | mV | |
| f_{PWM} | LED PWM频率 ⁽³⁾ | | 100 | | 800 | Hz | |
| I_{LED_MATCH} | LED电流匹配 | 不同 I_{LED1} - I_{LED5} 电流之间的变化。匹配LED引脚压差 < 250 mV ⁽⁴⁾ | $I_{LED} =$ 2.5 mA至10 mA | | 2.0 | 5.0 | % |
| | | | $I_{LED} =$ 10 mA至25 mA | | 1.0 | 3.5 | |
| $I_{LINEARITY}$ | LED电流线性 ⁽³⁾ | LED1 - LED5 | 1/255 ≤ PWM ≤ 24/255, 300 Hz | | | 10 | % |
| | | | PWM ≥ 25/255, 300 Hz | | | 2 | |
| I_{LED} | 绝对LED电流精度 | LED1 - LED5 | $I_{LED} =$ 2.5 mA至5 mA | | | 15.0 | % |
| | | | $I_{LED} =$ 5 mA至25 mA | | | 7.5 | |
| I_{LED_RIPPLE} | 峰间LED电流纹波 ⁽³⁾ | $V_{LED_DO} \leq 0.6\text{ V}$ (典型值0.29 V), $f_{PWM} = 300\text{ Hz}$, 测量值BW = 10 MHz | | 0.4 | 1.2 | mA _{P-P} | |
| $I_{LEAKAGE}$ | LED驱动器泄漏 | 处于关断状态 | | | 0.5 | μA | |
| V_{ISET} | ISET电压 | | | 1.20 | | V | |
| 逻辑控制 | | | | | | | |
| V_{IL} | 逻辑LOW阈值 | | | | 0.5 | V | |
| V_{IH} | 逻辑HIGH阈值 | | 1.05 | | | V | |
| R_{EN13} | EN13下拉电阻 | | | 250 | | k Ω | |
| R_{EN45} | EN45下拉电阻 | | | 250 | | k Ω | |

接下页

电气规格

若无其他说明： $V_{IN} = 2.3\text{ V}$ 至 5.5 V ， $T_A = -40^\circ\text{C}$ 至 85°C ，以及EN13和EN45 = “1”。典型值为 $V_{IN} = 3.7\text{ V}$ 、 $V_{OUT} = 6.8\text{ V}$ 、 $T_A = 25^\circ\text{C}$ 、 $I_{LED1-5} = 20\text{ mA}$ 。电路和器件依据图 1。

| 符号 | 参数 | 条件 | 最小值 | 典型值 | 最大值 | 单位 |
|-----------------|------------------|-------------|------|------|-----|------------------|
| 保护 | | | | | | |
| T_{TSD} | 过温关闭 | | | 150 | | $^\circ\text{C}$ |
| T_{HYS} | 过温滞后 | | | 25 | | $^\circ\text{C}$ |
| $V_{OV-RISE}$ | V_{OUT} 过压上升阈值 | | | 9.0 | | V |
| $V_{OV-FALL}$ | V_{OUT} 过压下降阈值 | | 8.25 | 8.60 | | V |
| V_{OV-HYS} | 滞环 | | | 400 | | mV |
| $V_{LED(SC)}$ | LED短路保护阈值 | | 0.7 | 1.0 | 1.4 | V |
| $I_{LED-SHORT}$ | 短路LED电流 | LED短路保护阈值跳变 | | | 1 | μA |

注意：

- 在闭环运行中，电感电流(I_L)比 I_{LIM-PK} 大30 mA至40 mA。
- 通过特性和设计保证。
- 对于LED输出，确定以下几项：
组中的最大LED电流(MAX)、组中的最小LED电流(MIN)，以及组的平均LED电流(AVG)。计算两个匹配数字： $(MAX - AVG) / AVG$ 和 $(AVG - MIN) / AVG$ 。两个中的较大数（最坏情况）视为组的匹配值。给定部分的匹配值视为两个组的最高匹配值。
提供的典型规格就是所有部分的最大可能匹配基准。
- LED驱动器压降是所有LED通道中最小的电压。

典型特性

$V_{IN} = 3.7\text{ V}$, $T_A = 25^\circ\text{C}$, $I_{LED} = 5 \times 20\text{ mA}$, $V_{OUT} = 6.8\text{ V}$, $L1 = 4.7\ \mu\text{H}$, 以及 $C_{OUT} = 10\ \mu\text{F}$ (除非另有规定)。

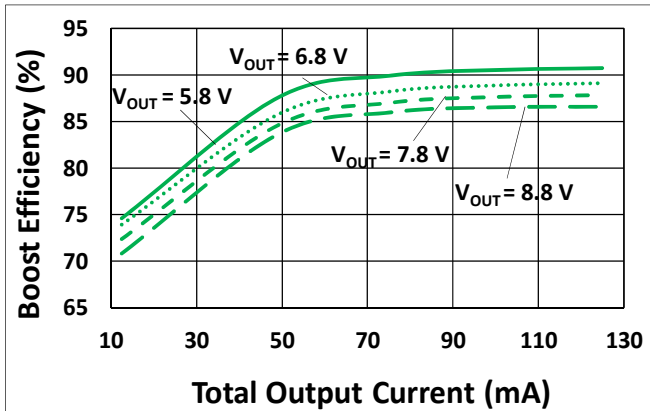


图 4. 升压效率与 输出电流和 输出电压

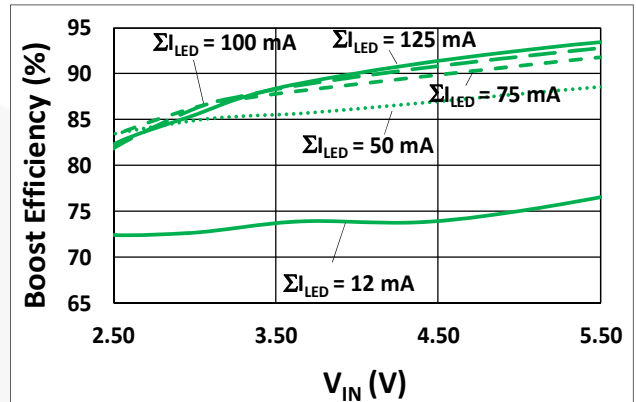


图 5. 升压效率与 输入电压和 总LED电流

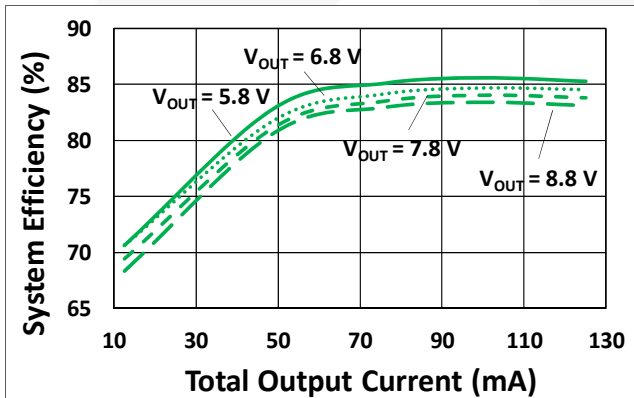


图 6. 总效率与 输出电流和 输出电压

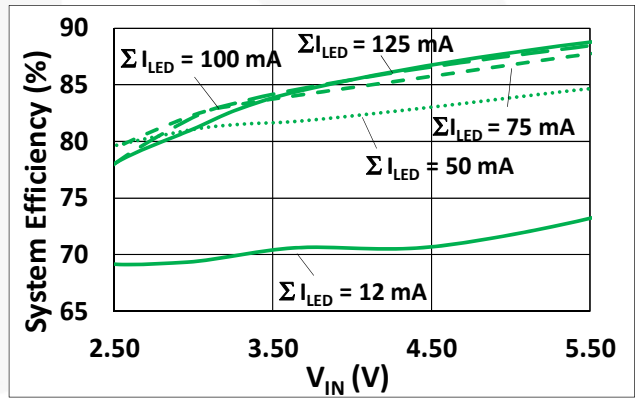


图 7. 总效率与 输入电压和 总LED电流

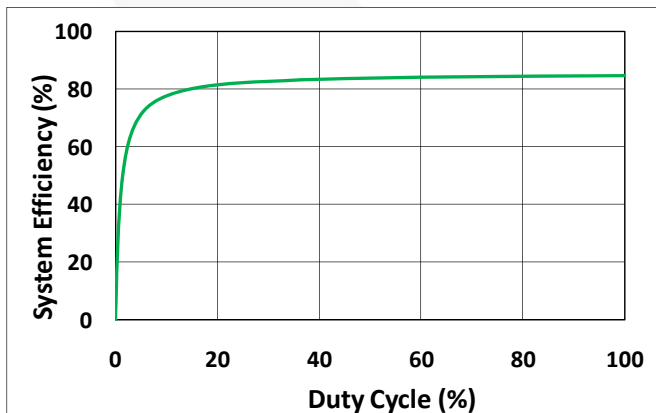


图 8. 总效率与 PWM占空比, $f_{PWM} = 300\text{ Hz}$

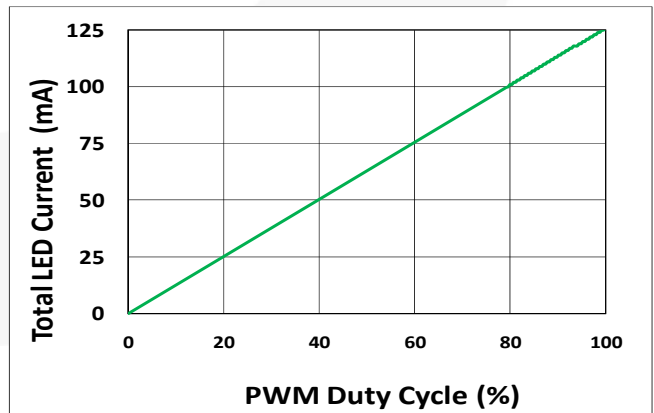


图 9. 总LED电流与 PWM占空比, $I_{LED} = 5 \times 25\text{ mA}$

典型特性

$V_{IN} = 3.7\text{ V}$ 、 $T_A = 25^\circ\text{ C}$ 、 $I_{LED} = 5 \times 20\text{ mA}$ 、 $V_{OUT} = 6.8\text{ V}$ 、 $L1 = 4.7\text{ }\mu\text{H}$ 、 $C_{OUT} = 10\text{ }\mu\text{F}$ （除非另有规定）。

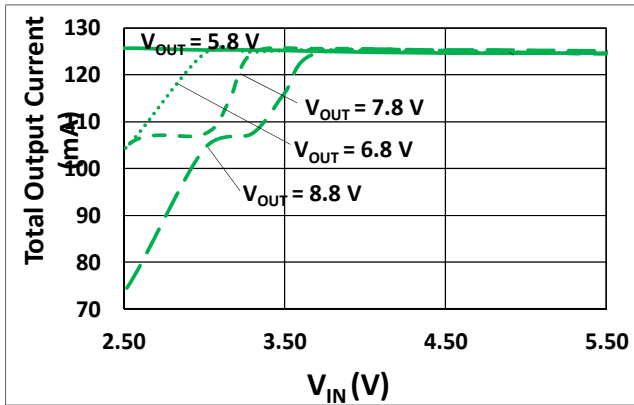


图 10. 最大输出电流 ($I_{LED} = 5 \times 25\text{ mA}$) 与输入电压和输出电压

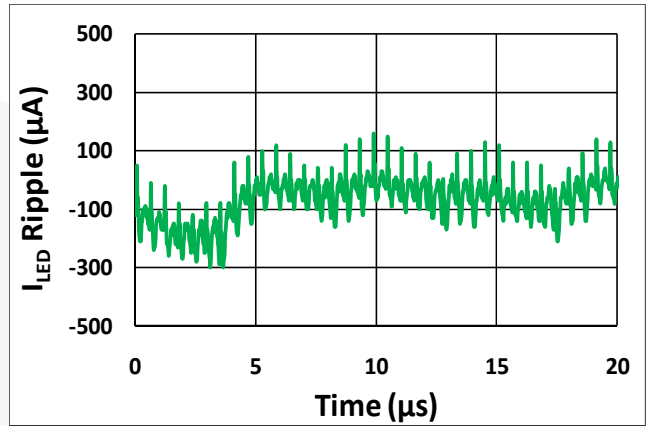


图 11. LED电流纹波

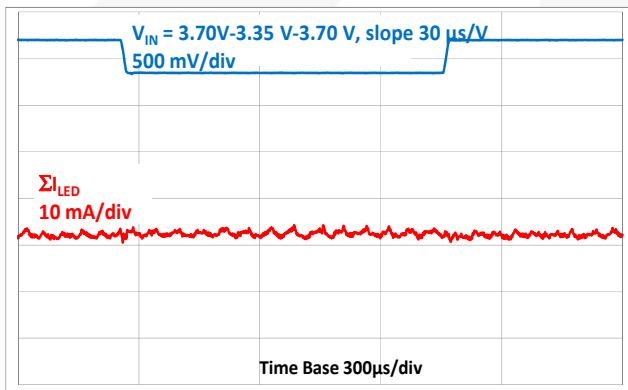


图 12. 线路瞬态响应
 $V_{IN} = 3.70 - 3.35\text{ V} - 3.70\text{ V}$ 、 $I_{LED} = 5 \times 25\text{ mA}$

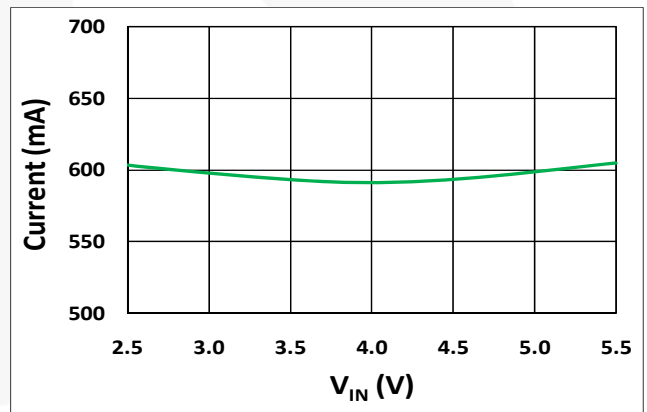


图 13. 峰值电感限流（闭环）与输入电压

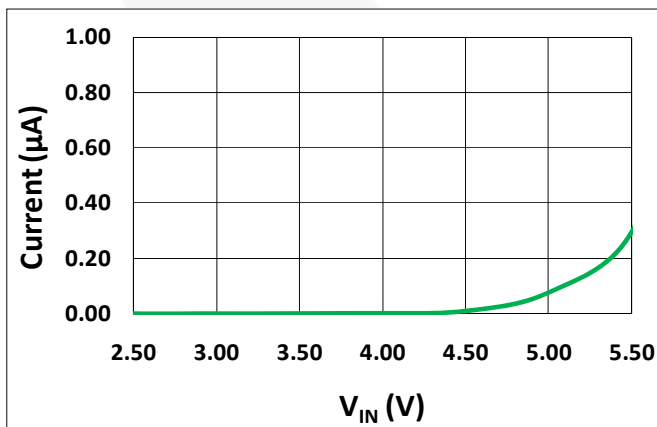


图 14. 关断电流与输入电压的关系

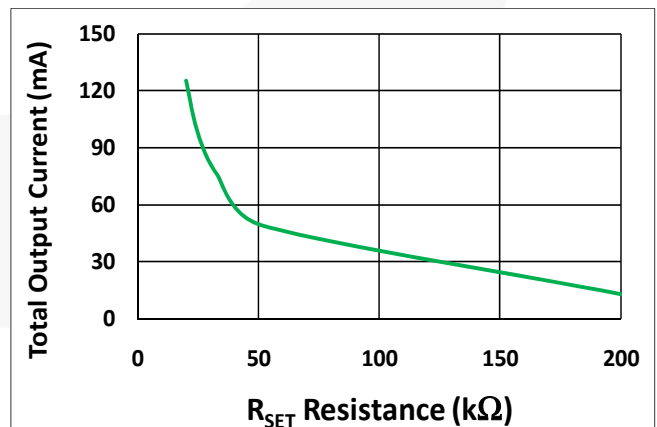


图 15. 总输出电流 I_{LED} 与 R_{SET} 电阻值

典型特性

$V_{IN} = 3.7\text{ V}$ 、 $T_A = 25^\circ\text{ C}$ 、 $I_{LED} = 5 \times 20\text{ mA}$ 、 $V_{OUT} = 6.8\text{ V}$ 、 $L1 = 4.7\text{ }\mu\text{H}$ 、 $C_{OUT} = 10\text{ }\mu\text{F}$ （除非另有规定）。

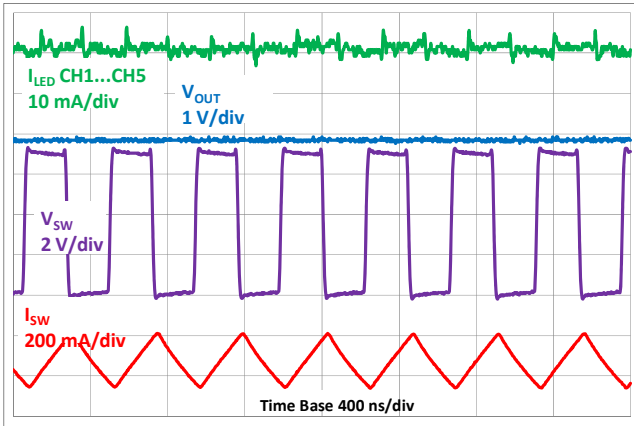


图 16. 开关波形 (V_{OUT} 、 V_{SW} 、 I_{SW})

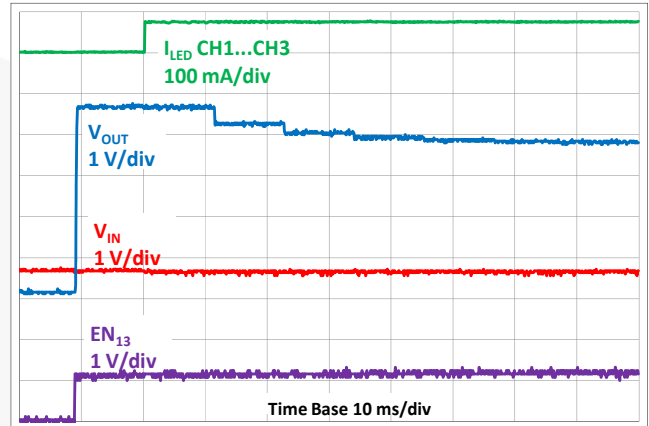


图 17. 使能后启动，连接三个灯串

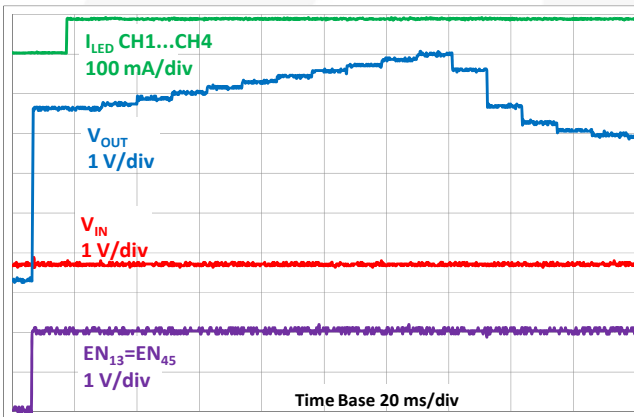


图 18. 使能后启动，连接四个灯串

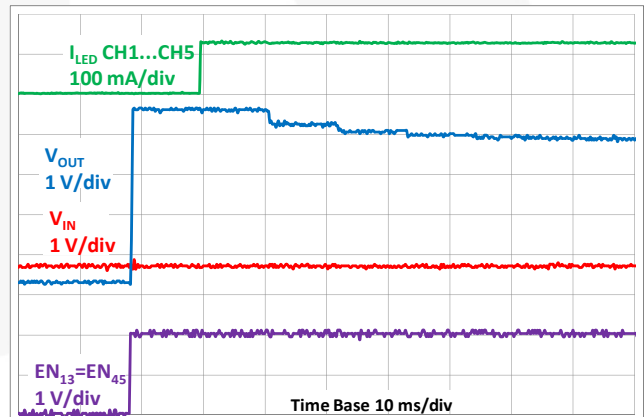


图 19. 使能后启动，连接五个灯串

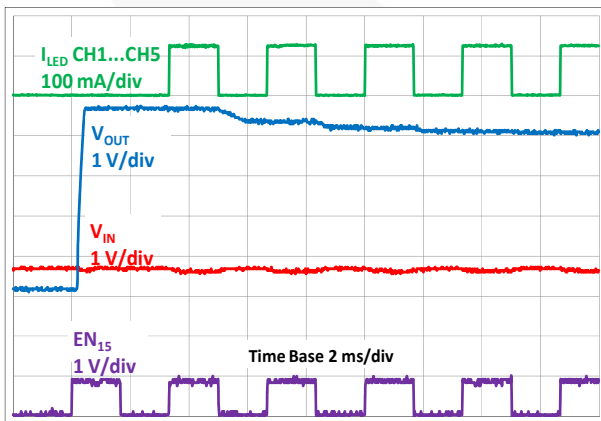


图 20. LED PWM启动，连接五个灯串

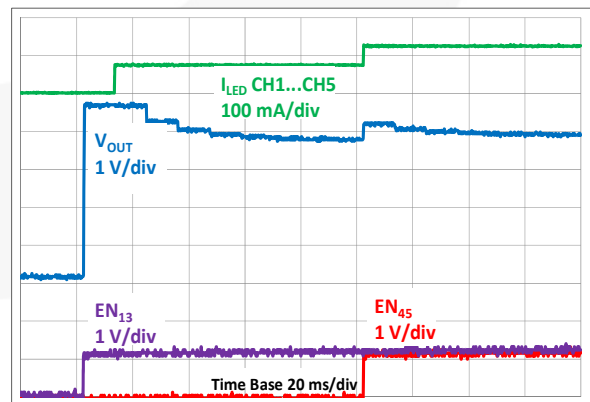


图 21. LED1-3使能，然后LED4-5使能后启动

典型特性

$V_{IN} = 3.7\text{ V}$ 、 $T_A = 25^\circ\text{ C}$ 、 $I_{LED} = 5 \times 20\text{ mA}$ 、 $V_{OUT} = 6.8\text{ V}$ 、 $L1 = 4.7\text{ }\mu\text{H}$ 、 $C_{OUT} = 10\text{ }\mu\text{F}$ （除非另有规定）。

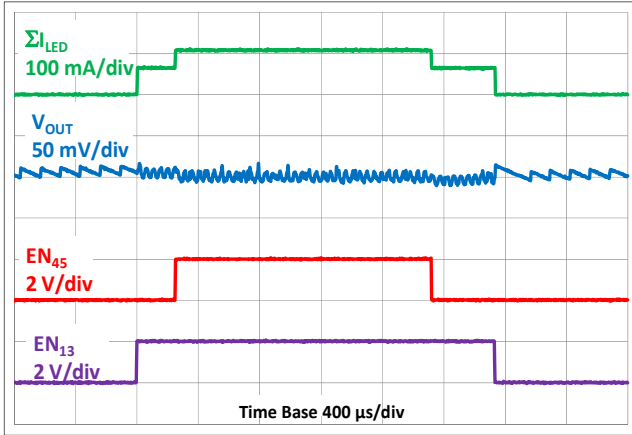


图 22. 异步LED PWM，每LED灯串两个LED

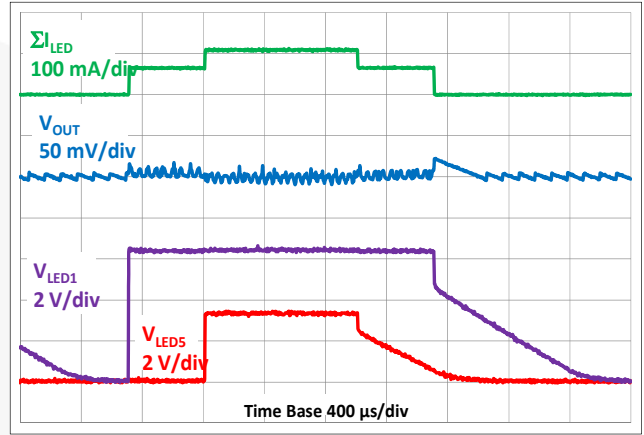


图 23. 异步LED PWM，LED1-3灯串上两个LED，LED4-5灯串上单个LED

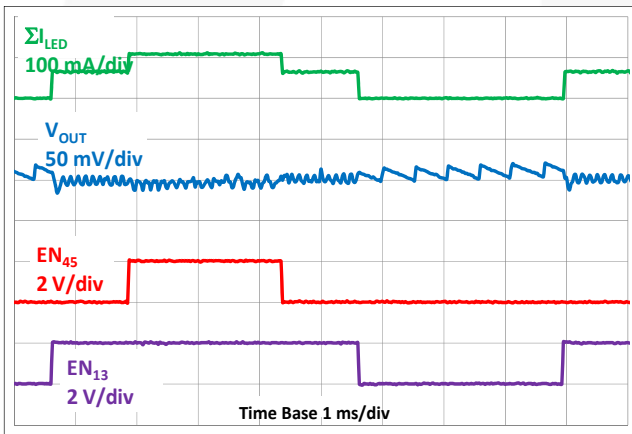


图 24. 异步LED PWM，对于常见负载，所有LED输出一起短路
请参见图 30

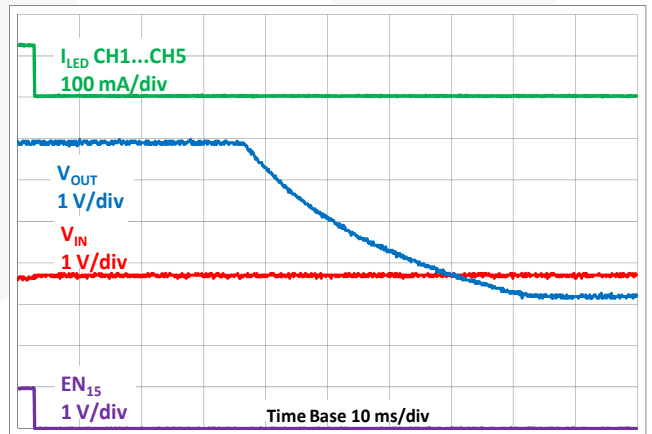


图 25. 器件被禁用，连接五个灯串



电路说明

概述

FAN5776为具有集成恒流高端LED驱动器的1.8 MHz同步升压DC-DC转换器，能够驱动一个至五个高达5 x 25 mA LED电流的LED灯串。

至少利用一个LED灯串且使能合适的EN引脚时，器件启动。通过将两个EN引脚均设置为LOW，在30 ms内禁用器件。

V_{OUT} 电压在内部设置为290 mV，高于最高LED灯串电压，并在每个下降LED PWM周期采样。对于100%占空比，对LED引脚电压采样，并且每10 ms改进一次 V_{OUT} 电压。

LED灯串可通过将其连接至VOUT或使其对GND短路来禁用。也可使其断开连接。如果LED灯串被暂时禁用或短路，器件必须被重新使能以再次使能灯串。

LED驱动器独立工作并允许多个LED电压，以便多种类型的LED可同时驱动，并且一些灯串可用于驱动单个LED，而其他通道以串联方式驱动两个LED。 V_{OUT} 电压由最高LED电压改进，并且LED驱动器压降增加以提供LED灯串特定的电压。如果LED灯串之间的压差很大，系统效率可能会降低。

LED 电流

LED灯串电流由ISET和GND引脚之间的电阻 R_{SET} 设置。相同电流供应给所有灯串以使总输出电流： $I_{OUT} = 5 \times I_{LED} = 5 \times 20 \text{ mA} = 100 \text{ mA}$ ，前提是 $R_{SET} = 25 \text{ k}\Omega$ 并且使用所有LED灯串。通常，LED灯串电流可由下列等式计算得出：

$$I_{LED} = \frac{500}{R_{SET}} \quad (1)$$

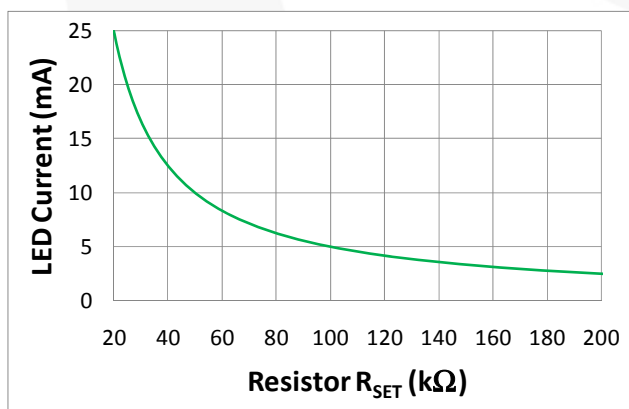


图 26. LED电流与 R_{SET} 值

启动

三种不同的启动功能取决于系统配置：

1. 使用所有LED灯串：
将一个或两个EN引脚设置为HIGH将使能器件并且 V_{OUT} 上升为7.5 V。FAN5776开始升压或降压至合适的调节电压。

2. 组中至少有一个LED灯串对GND短路。禁用短路LED灯串时， V_{OUT} 上升至7.5 V，并且器件开始升压或降压至调节电压。
3. 至少一个LED灯串浮动或连接至 V_{OUT} 。 V_{OUT} 上升至9.0 V，浮动LED灯串被禁用，并且器件开始升压或降压至调节电压。

三种功能单独为每个组工作。如果使用所有五个灯串并且EN13为HIGH， V_{OUT} 将上升至7.5 V（外壳1）并且到达LED1-3所需的最高电压。然后EN45上升并且 V_{OUT} 再次升压至7.5 V，并调节至LED1-5所需的最高电压。

如果 V_{OUT} 无法在一个使能周期后的1.2 ms内达到7.5 V，器件将保持禁用并且需要进行新使能周期。

PWM 调光

100 Hz至800 Hz的LED PWM信号可应用至EN13和EN45引脚以控制LED1-3和LED4-5光强度。LED电流是100%下至0.4%的LED PWM占空比的线性函数。FAN5776可通过具有低占空比的PWM信号启动以实现平滑启动。EN13和EN45引脚可同步也可异步操作，这样就使得使用器件来同时背光两个独立显示器成为可能。

欠压闭锁 (UVLO)

欠压闭锁电路关闭所有MOSFET，并且器件保持在极低静态电流状态直至 V_{IN} 上升至高于UVLO阈值。

短路保护 (SCP)

当LED编号引脚电压低于1.0 V时，LED驱动器输出电流限制为0.5 μ A或更小。此限制应在一个LED PWM周期或10 ms内应用，以先到者为准。

过压保护 (OVP)

当稳压器处于有源状态时，其监视VOUT引脚。如果 V_{OUT} 电压达到9.0 V，稳压器停止开关，直至VOUT的电容放电低于8.5 V。

LED-Open检测

如果检测到 V_{OUT} 在>9.0 V以上，将扫描LED电压。电压大于 $V_{OUT} - 0.5 \text{ V}$ 的所有LED引脚被禁用。如果所有LED引脚的电压均超过8.5 V且 V_{OUT} 大于9.0 V，器件将禁用并且需要进行新启动周期。

过流保护 (OCP)

PWM转换器通过使用固定内部限制的逐周期限流受过载保护。

热关断

晶圆温度超过150° C时，发生复位并保持，直至晶圆冷却至125° C；此时电路进入正常软启动序列。

应用

外部元件的选择

对FAN5776上电需要四个外部组件：

V_{IN}和SW引脚之间的电感、输出上的存储电容、输入上的存储电容和ISET引脚上的参考电阻。

电感器的最小电感要求为2.45 μH，500 mA偏置电流、1.8 MHz频率时ESR ≤ 300 mΩ。电感更低会降低器件的效率，而电感更高会减少输出纹波。

输出电容的最小电容为5 V时4.8 μF。注意，陶瓷电容值取决于DC偏置电压。检查电容的数据手册，确保电容符合所有规格。

要改进器件的瞬态特性，建议输入电容使用2.2 μF。请确保V_{IN}电源电压没有纹波，以获得最佳器件性能。

参考电阻值至少为20 kΩ。LED电流精度由此电阻定义，建议使用具有低温度依赖性的高精度电阻。为保证FAN5776的性能并实现25 mA的I_{LED}最大电流，必须使用20 kΩ、±1%或更好的电阻。

PCB布局指南

建议使用独立接地层以最大程度地减少噪音。将FAN5776器件、电感(L)、C_{IN}和C_{OUT}电容及其互连放在板的相同侧。建议使用通过电感从电源电压至SW引脚的高电流通路到接地层的GND引脚作为低电阻路径。使V_{OUT}引脚至C_{OUT}电容路径尽可能短以最大程度地减小低V_{OUT}纹波电压的V_{OUT}引脚至C_{OUT}的电感。最大程度地减小SW引脚电容以实现最佳系统效率。使ISET引脚至R_{SET}电阻路径尽可能远离噪声信号(SW引脚)，以最大程度地减小从SW引脚至ISET引脚的串扰。

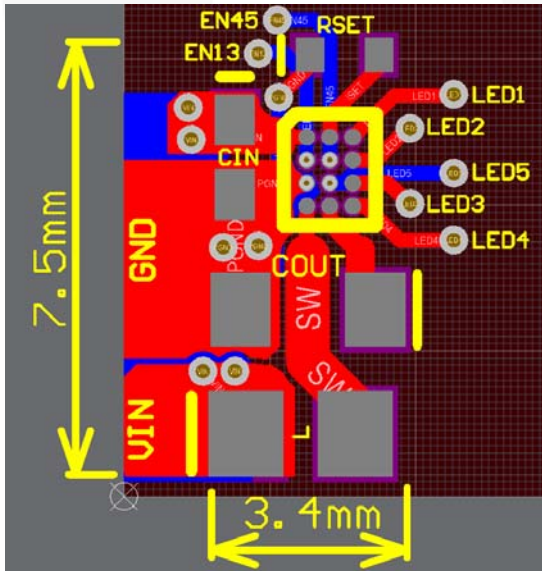


图 27. 推荐PCB布局

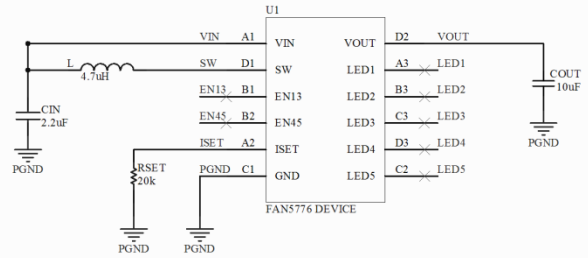


图 28. 推荐布局的原理图

启动电源最小化

FAN5776经过优化，可在所有五个LED驱动器输出均连接至LE时最小化启动电源。如果由于LCD显示器更小而不使用其中一些LED灯串，仍可最小化启动电源。将未使用的LED驱动器输出连接到接地(GND)可防止启动期间LED电流下降，并且V_{out}在7.5 V时启动，这可减少功耗。其次，连接到GND的未使用的LED驱动器输出在启动时被禁用，从而最大程度地减少到GND的漏电流。如果保持开路，未使用的LED灯串可导致V_{out}上升至9.0 V的0 VP电压，而非在7.5 V时启动。器件检测到由于未使用的LED字符串而导致的开路，因此上升到9.0 V，然后调节到适合对LED灯串上电的V_{out}。

当未使用的LED驱动器连接到V_{OUT}引脚或保持浮动时，器件也会按规范工作。

组合的LCD背光和闪光信号灯

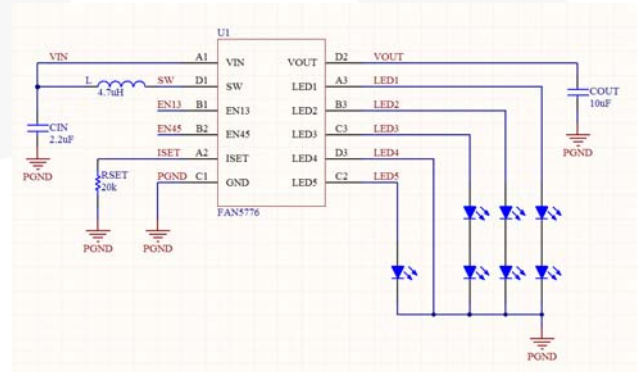


图 29. 屏幕背光和闪光信号灯的原理图

FAN5776配置为符合设计需求后，可用于不同照明应用。每个LED驱动器输出都是独立的，以便每个输出在得到同时控制时，都可支持不同的输出电压。

为FAN5776的每个输出配置不同数量的LED会导致系统效率降低，因为具有单个LED的输出的压降比具有两个串联LED的输出高。系统效率(η)由以下等式计算：

$$\eta = \sum_{i=1}^5 \frac{I_i V_i}{I_{IN} V_{IN}} \quad (2)$$

其中：

- I_i 是LED(i)通道电流；
- V_i 是LED(i)通道电压；
- I_{IN} 是电源电流(rms)；以及
- V_{IN} 为电源电压(rms)。

如果所有LED灯串相等，则使用 $I_1 = I_2 = \dots = I_5$ 、 $V_1 = V_2 = \dots = V_5$ 以及N通道(N = 1、2、3、4或5)，等式简化为：

$$\eta = N \frac{I_{LED} V_{LED}}{I_{IN} V_{IN}} \quad (3)$$

其中：

- I_{LED} 是LED通道电流(总输出电流为 $N * I_{LED}$)和 V_{LED} 是LED通道电压。

有两个各具有单独控制的LED输出组。EN13和EN45引脚分别是LED1-3和LED4-5输出的控制/PWM。

图

29说明FAN5776使用三个具有两个串联LED的LED输出(LED1至LED3)对主LCD显示器进行背光,同时LED5对单个LED供电用于闪烁功能。LED4未使用并连接至GND。LCD显示器的LED的背光和PWM调光受EN13的控制,同时EN45控制LED5的闪烁和调光等级。

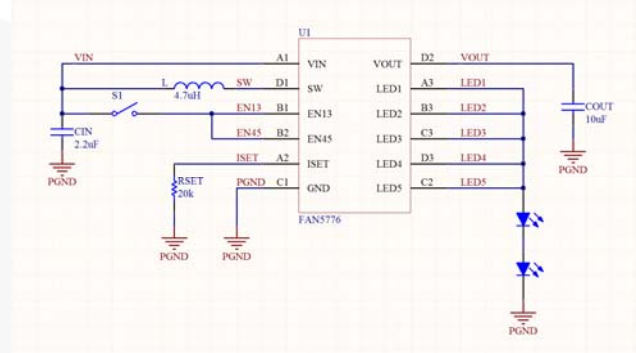


图 30. 闪光灯应用的原理图

要使用FAN5776作为LED闪光灯驱动器,如图30中所示,将VIN连接到电池电压,并添加单刀双掷开关(机械或电气)(从EN13和/或EN45引脚至VIN。)当开关处于非导通状态时,EN引脚上的下拉电阻禁用器件。

物理尺寸

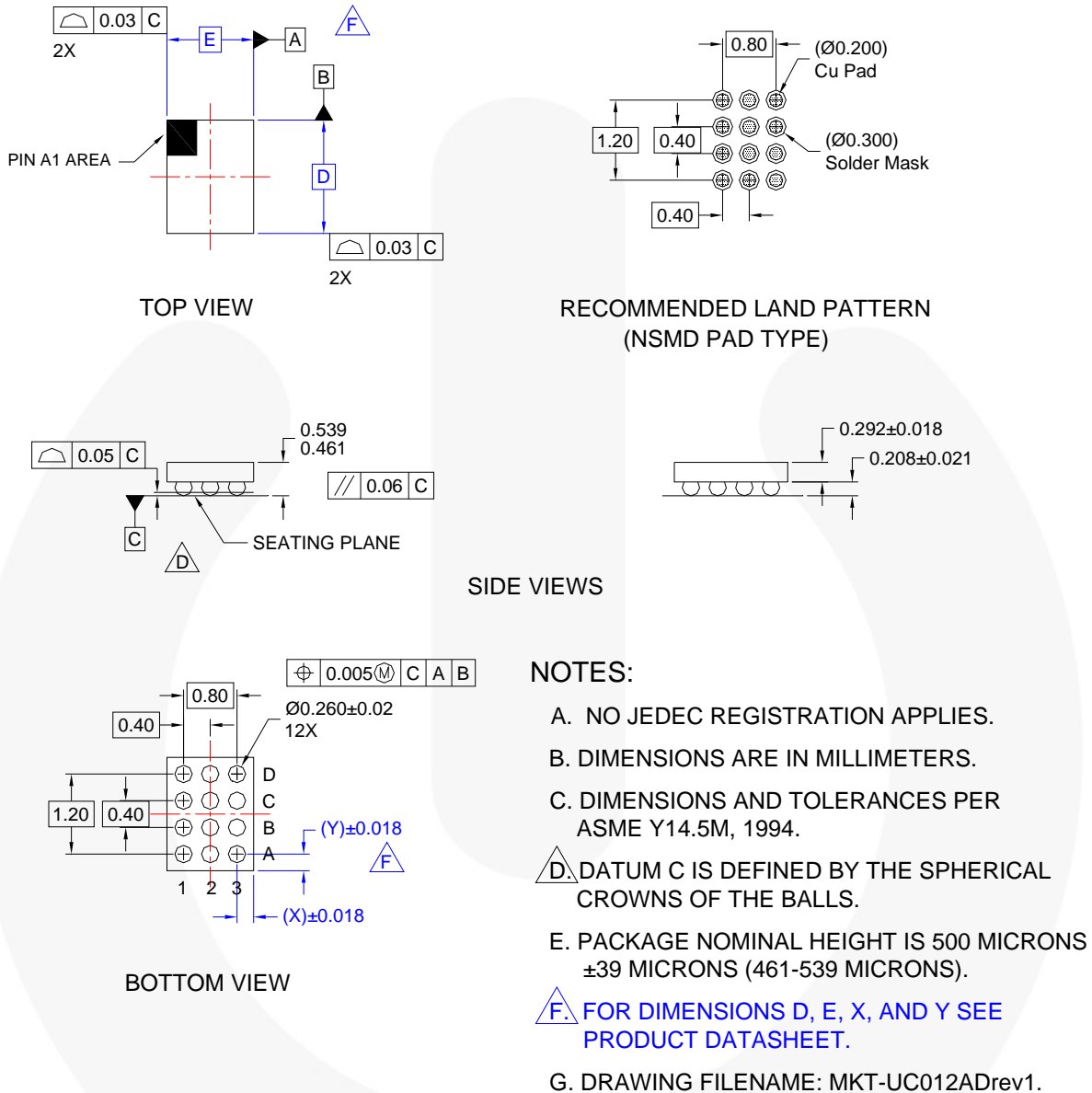


图 31. 12凸块、晶圆级芯片尺寸封装 (WLCSP) 1.42 x 1.66 x 0.50 mm, 0.40 mm间距

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|----------|----------|----------|----------|
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